

2SK3479

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

NEC

The 2SK3479 is N-channel MOS Field Effect Transistor designed for high current switching applications.

FEATURES

- Super low on-state resistance:
- $R_{DS(on)1} = 11 \text{ m}\Omega \text{ MAX.} (V_{GS} = 10 \text{ V}, \text{ ID} = 42 \text{ A})$
- $R_{DS(on)2} = 13 \text{ m}\Omega \text{ MAX.} (V_{GS} = 4.5 \text{ V}, \text{ ID} = 42 \text{ A})$
- Low Ciss: $C_{iss} = 10900 \text{ pF TYP}$.
- Built-in gate protection diode

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage	VDSS	100	V
Gate to Source Voltage	VGSS(AC)	±20	V
Drain Current (DC)	D(DC)	±83	А
Drain Current (pulse) ^{Note1}	D(pulse)	±332	А
Total Power Dissipation (Tc = 25°C)	PT	125	W
Total Power Dissipation ($T_A = 25^{\circ}C$)	PT	1.5	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current ^{Note2}	las	T.B.D. Note3	А
Single Avalanche Energy ^{Note2}	Eas	T.B.D. ^{Note3}	mJ

Notes 1. PW \leq 10 μ s, Duty cycle \leq 1%

- **2.** Starting Tch = 25°C, RG = 25 Ω , VGS = 20 V \rightarrow 0 V
- 3. T.B.D. : To be determined

THERMAL RESISTANCE

Channel to Case	Rth(ch-C)	1.00	°C/W
Channel to Ambient	Rth(ch-A)	83.3	°C/W

ORDERING INFORMATION

PART NUMBER	PACKAGE	
2SK3479	TO-220AB	
2SK3479-S	TO-262	
2SK3479-ZJ	TO-263	
2SK3479-Z	TO-220SMD ^{Note}	

Note TO-220SMD package is produced only in Japan.

(TO-220AB)



(TO-262)



(TO-263, TO-220SMD)



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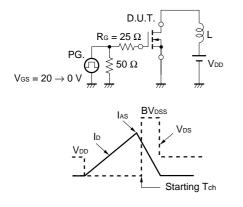
ELECTRICAL CHARACTERISTICS (TA = 25°C)

NEC

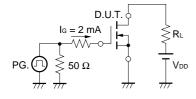
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, Id = 42 A		8.8	11	mΩ
	RDS(on)2	Vgs = 4.5 V, Id = 42 A		9.6	13	mΩ
Gate to Source Cut-off Voltage	VGS(off)	$V_{DS} = 10 V, I_{D} = 1 mA$	1.5	2.0	2.5	V
Forward Transfer Admittance	y _{fs}	$V_{DS} = 10 V, I_D = 42 A$	37	75		S
Drain Leakage Current	IDSS	Vds = 100 V, Vgs = 0 V			10	μA
Gate to Source Leakage Current	lgss	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±10	μA
Input Capacitance	Ciss	$V_{DS} = 10 V, V_{GS} = 0 V, f = 1 MHz$		10900		pF
Output Capacitance	Coss			1100		pF
Reverse Transfer Capacitance	Crss			550		pF
Turn-on Delay Time	td(on)	$I_{D}=42A,\;V_{GS(on)}=10V,\;V_{DD}=50V,$		35		ns
Rise Time	tr	$R_G = 1 \Omega$		25		ns
Turn-off Delay Time	td(off)			180		ns
Fall Time	tr			35		ns
Total Gate Charge	QG	$I_{\text{D}}=83\text{A}$, $V_{\text{DD}}=80\text{V},V_{\text{GS}}=10\text{V}$		200		nC
Gate to Source Charge	QGS			31		nC
Gate to Drain Charge	Qgd			55		nC
Body Diode Forward Voltage	VF(S-D)	IF = 83 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 83 A, VGS = 0 V,		95		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/µs		180		nC

TEST CIRCUIT 1 AVALANCHE CAPABILITY

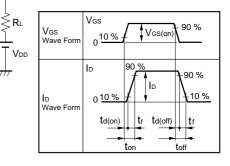
TEST CIRCUIT 2 SWITCHING TIME



TEST CIRCUIT 3 GATE CHARGE



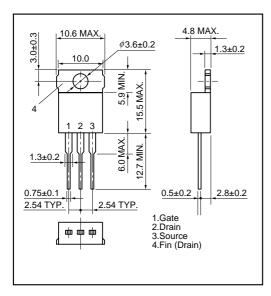
D.U.T. PG. RG τ τ τ τ Duty Cycle $\leq 1 \%$



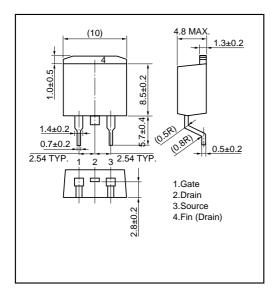
Preliminary Product Information D15077EJ1V0PM00

PACKAGE DRAWINGS (Unit: mm)

1) TO-220AB(MP-25)

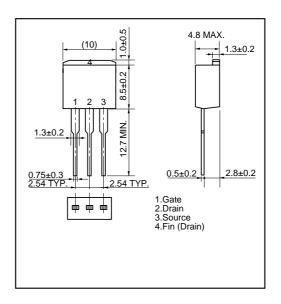


3) TO-263 (MP-25ZJ)

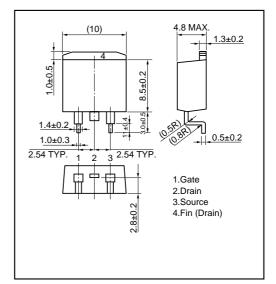


Remark

2) TO-262(MP-25 Fin Cut)

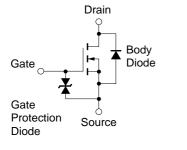


4) TO-220SMD(MP-25Z)^{Note}



Note This Package is produced only in Japan.

EQUIVALENT CIRCUIT



The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

Preliminary Product Information D15077EJ1V0PM00

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